Lattice Semiconductor Corporation - LC5512MC-75QN208C Datasheet

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Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	1.65V ~ 1.95V
Number of Logic Elements/Blocks	16
Number of Macrocells	512
Number of Gates	-
Number of I/O	149
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5512mc-75qn208c

Product Line	Ordering Part Number	Product Status	Reference PCN
LC5512MV	LC5512MV-45Q208C	Active / Orderable	
	LC5512MV-45QN208C		
	LC5512MV-75Q208C		
	LC5512MV-75QN208C		
	LC5512MV-75Q208I		
	LC5512MV-75QN208I		
	LC5512MV-45F256C		
	LC5512MV-45FN256C		
	LC5512MV-75F256C		
	LC5512MV-75FN256C		
	LC5512MV-75F256I		
	LC5512MV-75FN256I		
	LC5512MV-45F484C		
	LC5512MV-45FN484C		
	LC5512MV-75F484C		
	LC5512MV-75FN484C		
	LC5512MV-75F484I		
	LC5512MV-75FN484I		
LC5512MB	LC5512MB-45Q208C	**Discontinued**	PCN#09-10
	LC5512MB-45QN208C		
	LC5512MB-75Q208C		
	LC5512MB-75QN208C		
	LC5512MB-75Q208I		
	LC5512MB-75QN208I		
	LC5512MB-45F256C	Active / Orderable	
	LC5512MB-45FN256C		
	LC5512MB-75F256C		
	LC5512MB-75FN256C		
	LC5512MB-75F256I		
	LC5512MB-75FN256I		
	LC5512MB-45F484C	**Discontinued**	PCN#09-10
	LC5512MB-45FN484C		
	LC5512MB-75F484C		
	LC5512MB-75FN484C		
	LC5512MB-75F484I		
	LC5512MB-75FN484I		
LC5512MC	LC5512MC-45Q208C	**Discontinued**	PCN#09-10
	LC5512MC-45QN208C		
	LC5512MC-75Q208C		
	LC5512MC-75QN208C		
	LC5512MC-75Q208I		
	LC5512MC-75QN208I		
	LC5512MC-45F256C		
	LC5512MC-45FN256C		
	LC5512MC-75F256C		
	LC5512MC-75FN256C		
	LC5512MC-75F256I		
	LC5512MC-75FN256I		

True Dual-Port SRAM Mode

In Dual-Port SRAM Mode the multi-function array is configured as a dual port SRAM. In this mode two independent read/write ports access the same 8,192-bits of memory. Data widths of 1, 2, 4, 8, and 16 are supported by the MFB. Figure 9 shows the block diagram of the dual port SRAM.

Write data, address, chip select and read/write signals are always synchronous (registered.) The output data signals can be synchronous or asynchronous. Resets are asynchronous. All inputs on the same port share the same clock, clock enable, and reset selections. All outputs on the same port share the same clock, clock enable, and reset selections. Selections may be made independently between both inputs and outputs and ports. Table 5 shows the possible sources for the clock, clock enable and initialization signals for the various registers.

Figure 9. Dual-Port SRAM Block Diagram

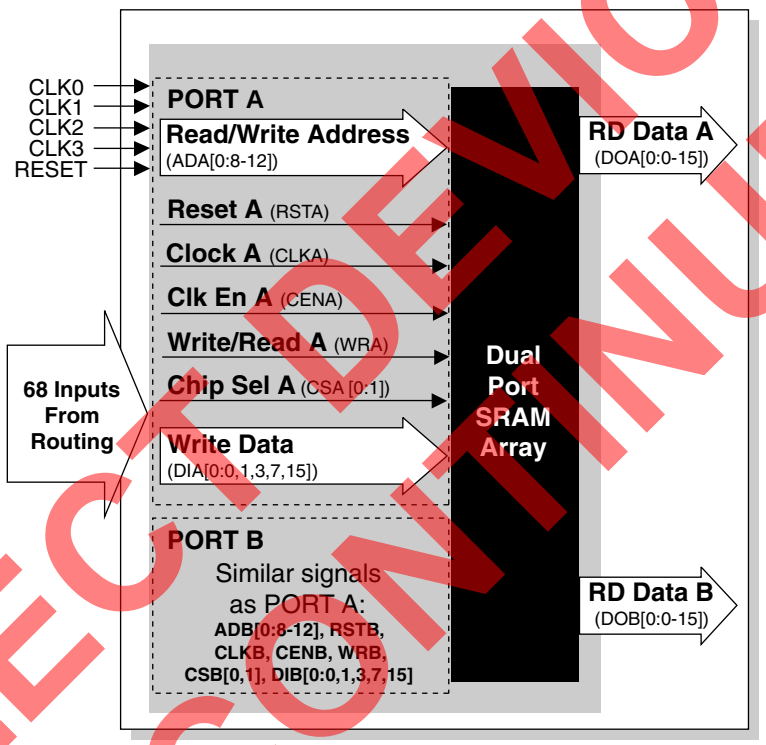


Table 5. Register Clock, Clock Enable, and Reset in Dual-Port SRAM Mode

Register	Input	Source
Address, Write Data, Read Data, Read/ Write, and Chip Select	Clock	CLKA (CLKB) or one of the global clocks (CLK0 - CLK3). The selected signal can be inverted if desired.
	Clock Enable	CENA (CENB) or one of the global clocks (CLK1 - CLK 2). The selected signal can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RSTA (RSTB). RSTA (RSTB) can be inverted is desired.

Single-Port SRAM Mode

In Single-Port SRAM Mode the multi-function array is configured as a single-port SRAM. In this mode one ports accesses 16,384-bits of memory. Data widths of 1, 2, 4, 8, 16 and 32 are supported by the MFB. Figure 11 shows the block diagram of the single-port SRAM.

Write data, address, chip select and read/write signals are always synchronous (registered.) The output data signals can be synchronous or asynchronous. Reset is asynchronous. All signals share a common clock, clock enable, and reset. Table 7 shows the possible sources for the clock, clock enable and reset signals.

Figure 11. Single-Port SRAM Block Diagram

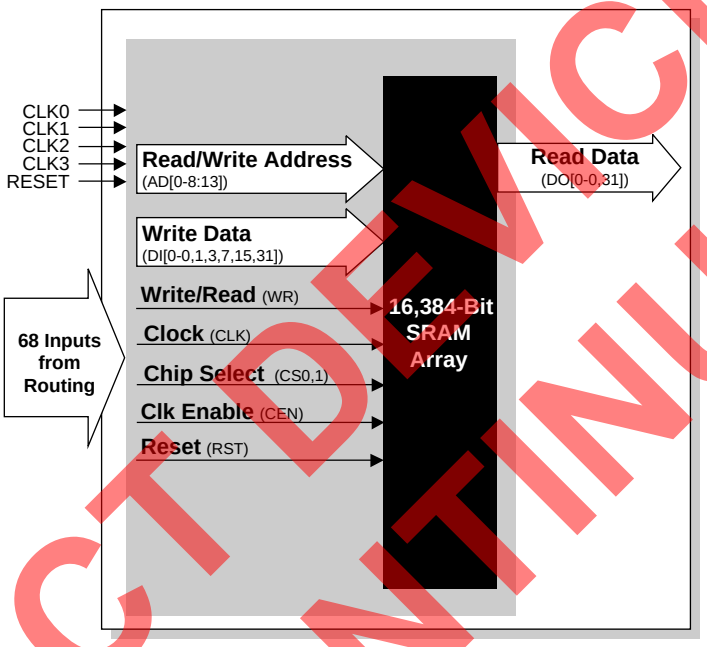


Table 7. Register Clock, Clock Enable, and Reset in Single-Port SRAM Mode

Register	Input	Source
Address, Write Data, Read Data, Read/ Write, and Chip Select	Clock	CLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	CEN or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired.

FIFO Mode

In FIFO Mode the multi-function array is configured as a FIFO (First In First Out) buffer with built in control. The read and write clocks can be different or the same dependent on the application. Four flags show the status of the FIFO; Full, Empty, Almost Full, and Almost Empty. The thresholds for Full, Almost full and Almost empty are programmable by the user. It is possible to reset the read pointer, allowing support of frame retransmit in communications applications. If desired, the block can be used in show ahead mode allowing the early reading of the next read address.

In this mode one ports accesses 16,384-bits of memory. Data widths of 1, 2, 4, 8, 16 and 32 are supported by the MFB. Figure 12 shows the block diagram of the FIFO.

Write data, write enable, flag outputs and read enable are synchronous. The Write Data, Almost Full and Full share the same clock and clock enables. Read outputs are synchronous although these can be configured in look ahead mode. The Read Data, Empty and Almost Empty signals share the same clock and clock enables. Reset is shared by all signals. Table 8 shows the possible sources for the clock, clock enable and reset signals for the various registers.

Figure 12. FIFO Block Diagram

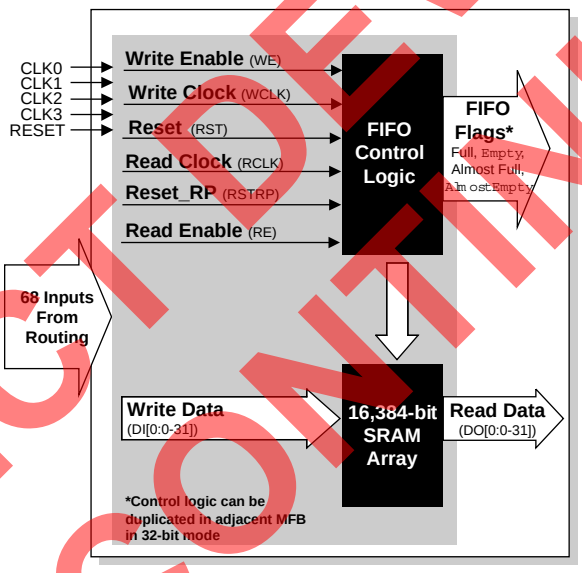


Table 8. Register Clocks, Clock Enables, and Initialization in FIFO Mode

Register	Input	Source
Write Data, Write Enable	Clock	WCLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	WE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	N/A
Full and Almost Full Flags	Clock	WCLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	WE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired.
Read Data, Empty and Almost Empty Flags	Clock	RCLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	RE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired.

sysIO Recommended Operating Conditions

Standard	V_{CCO} (V)[2]			V_{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVCMOS 3.3	3.0	3.3	3.6	—	—	—
LVCMOS 2.5	2.3	2.5	2.7	—	—	—
LVCMOS 1.8[1]	1.65	1.8	1.95	—	—	—
LVTTL	3.0	3.3	3.6	—	—	—
PCI 3.3	3.0	3.3	3.6	—	—	—
AGP-1X	3.15	3.3	3.45	—	—	—
SSTL 2	2.3	2.5	2.7	1.15	1.25	1.35
SSTL 3	3.0	3.3	3.6	1.3	1.5	1.7
CTT 3.3	3.0	3.3	3.6	1.35	1.5	1.65
CTT 2.5	2.3	2.5	2.7	1.35	1.5	1.65
HSTL Class I	1.4	1.5	1.6	0.68	0.75	0.9
HSTL Class III	1.4	1.5	1.6	—	0.9	—
HSTL Class IV	1.4	1.5	1.6	—	0.9	—
GTL+	1.4	—	3.6	0.882	1.0	1.122
LVDS	2.3	2.5/3.3	3.6	—	—	—

1. Design tools default setting.
2. Inputs are independent of V_{CCO} setting. However, V_{CCO} must be set within the valid operating range for one of the supported standards.

ispXPLD 5000MX Family External Switching Characteristics [1, 2, 3]

Over Recommended Operating Conditions

Parameter	Description	-4		-45		-5		-52		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{PD}	Data Propagation Delay, 5-PT Bypass	—	4.0	—	4.5	—	5.0	—	5.2	—	7.5	ns
t_{PD_PTSA}	Data propagation delay	—	4.8	—	5.7	—	6.0	—	6.5	—	9.5	ns
t_S	MFB Register Setup Time Before Clock, 5-PT Bypass	2.2	—	2.8	—	2.8	—	3.0	—	4.5	—	ns
t_{S_PTSA}	MFB Register Setup Time Before Clock	2.5	—	3.1	—	3.1	—	3.6	—	5.5	—	ns
t_{SIR}	MFB Register Setup Time Before Clock, Input Register Path	1.0	—	1.0	—	1.0	—	0.5	—	1.7	—	ns
t_H	MFB Register Hold Time Before Clock, 5-PT Bypass	0.0	—	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{H_PTSA}	MFB Register Hold Time Before Clock	0.0	—	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{HIR}	MFB Register Hold Time Before Clock, Input Register Path	0.5	—	0.5	—	0.5	—	1.0	—	1.3	—	ns
t_{CO}	MFB Register Clock-to-Output Delay	—	2.8	—	3.0	—	3.2	—	3.7	—	5.0	ns
t_R	External Reset Pin to Output Delay	—	4.0	—	4.5	—	5.0	—	5.0	—	7.5	ns
t_{RW}	Reset Pulse Duration	1.8	—	1.8	—	1.8	—	2.0	—	3.0	—	ns
$t_{LPTOE/DIS}$	Input to Output Local Product Term Output Enable/Disable	—	6.0	—	7.0	—	7.5	—	8.5	—	10.5	ns
$t_{SPTOE/DIS}$	Input to Output Shared Product Term Output Enable/Disable	—	6.0	—	7.0	—	7.5	—	8.5	—	10.5	ns
$t_{GOE/DIS}$	Global OE Input to Output Enable/Disable	—	4.5	—	5.5	—	5.5	—	6.5	—	7.5	ns
t_{CW}	Clock Width, High or Low	1.5	—	1.5	—	1.5	—	1.8	—	2.5	—	ns
t_{GW}	Gate Width Low (for Low Transparent) or High (for High Transparent)	1.5	—	1.5	—	1.5	—	1.8	—	2.5	—	ns
t_{WIR}	Input Register Clock Width, High or Low	1.5	—	1.5	—	1.5	—	1.8	—	2.5	—	ns
t_{SKEW}	Clock-to-Out Skew, Block Level	—	0.6	—	0.6	—	0.6	—	0.6	—	1.0	ns
f_{MAX} [4]	Clock Frequency with Internal Feedback	—	300	—	275	—	250	—	250	—	150	MHz
f_{MAX} (Ext.)	Clock Frequency with External Feedback, $1/(t_S + t_{CO})$	—	200	—	171	—	166	—	149	—	105	MHz
f_{MAX} (Tog.)	Clock Frequency Max. Toggle	—	333	—	333	—	333	—	277	—	200	MHz
f_{MAX} (CAMC)[5]	Clock Frequency to CAM (Configure Mode)	—	280	—	280	—	230	—	230	—	168	MHz
f_{MAX} (CAM)[5]	Clock Frequency to CAM (Compare Mode)	—	150	—	150	—	150	—	135	—	90	MHz

ispXPLD 5000MX Family External Switching Characteristics (Continued)[1, 2, 3]

Over Recommended Operating Conditions

Parameter	Description	-4		-45		-5		-52		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
f_{MAX} (RAM)[5]	Clock Frequency to RAM in:											
	Single Port Mode	—	155	—	155	—	155	—	155	—	93	MHz
	Dual Port Mode	—	155	—	155	—	155	—	155	—	93	MHz
	Pseudo Dual Port Mode	—	180	—	180	—	160	—	160	—	106	MHz
f_{MAX} (FIFO)[5]	Clock Frequency to FIFO	—	225	—	220	—	210	—	210	—	132	MHz
t_{PWR_ON}	Power-on Time	—	200	—	200	—	200	—	200	—	200	µs

Timing v.1.8

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate timing for other standards.
2. Measured using standard switching circuit, global routing loading of 1, worst case PTSA loading and 1 output switching.
3. Pulse widths and clock widths less than minimum will cause unknown behavior.
4. Standard 16-bit counter using GRP feedback.
5. CAM, FIFO, RAM f_{MAX} specification used shared PT Clk.

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
Registered Delays													
t_S	D-Register Setup Time, Global Clock	—	0.28	—	0.31	—	0.35	—	0.55	—	0.52	—	ns
t_{S_PT}	D-Register Setup Time, PT Clock	—	-0.13	—	-0.11	—	-0.10	—	-0.10	—	-0.07	—	ns
t_H	D-Register Hold Time	—	1.90	—	2.56	—	2.50	—	2.40	—	4.00	—	ns
t_{COi}	Register Clock to OSA Time	—	—	0.72	—	1.03	—	0.68	—	0.93	—	1.50	ns
t_{CESi}	Clock Enable Setup Time	—	1.07	—	1.20	—	1.33	—	1.33	—	2.00	—	ns
t_{CEHi}	Clock Enable Hold Time	—	0.00	—	0.00	—	0.00	—	0.00	—	0.00	—	ns
t_{SIR}	D-Input Register Setup Time, Global Clock	—	0.66	—	0.20	—	0.53	—	0.12	—	0.08	—	ns
t_{SIR_PT}	D-Input Register Setup Time, PT Clock	—	0.42	—	0.37	—	0.34	—	0.34	—	0.22	—	ns
t_{HIR}	D-Input Register Hold Time, Global Clock	—	0.84	—	1.31	—	1.01	—	1.41	—	2.91	—	ns
t_{HIR_PT}	D-Input Register Hold Time, PT Clock	—	0.00	—	0.00	—	0.00	—	0.00	—	0.00	—	ns
Latched Delays													
t_{SL}	Latch Setup Time, Global Clock	—	0.18	—	0.00	—	0.00	—	0.00	—	0.00	—	ns
t_{SL_PT}	Latch Setup Time, PT Clock	—	0.18	—	0.00	—	0.00	—	0.00	—	0.34	—	ns
t_{HL}	Latch Hold Time	—	-0.06	—	0.00	—	0.00	—	0.00	—	-0.03	—	ns
t_{GOi}	Latch Gate to OSA Time	—	—	0.07	—	0.08	—	0.08	—	0.08	—	0.13	ns
t_{PDLi}	Propagation Delay through Latch to OSA Transparent	—	—	0.52	—	0.58	—	0.65	—	0.65	—	0.97	ns
Reset and Set Delays													
t_{SRi}	Asynchronous Reset or Set to OSA Delay	—	—	0.23	—	0.26	—	0.29	—	0.29	—	0.43	ns
t_{SRR}	Asynchronous Reset or Set Recovery	—	—	0.42	—	0.47	—	0.53	—	0.55	—	0.79	ns
eXtended Function Routing Delays													
$t_{ROUTEMF}$	Delay through SRP when Implementing Memory Functions	—	—	2.00	—	2.25	—	2.51	—	2.61	—	3.76	ns

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{PDPRWH}	R/W Hold time after Clock Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{PDPDATAS}$	Data Setup before Clock Time	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
$t_{PDPDATAH}$	Data Hold time after Clock Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{PDPRCLKO}$	Read Clock to Output Delay	—	—	5.08	—	5.02	—	5.66	—	5.45	—	8.54	ns
$t_{PDPCLKSKEW}$	Opposite Clock Cycle Delay	—	1.40	—	1.40	—	1.76	—	1.76	—	1.83	—	ns
$t_{PDPRSTO}$	Reset to RAM Output Delay	—	—	3.30	—	3.30	—	4.13	—	4.13	—	4.29	ns
$t_{PDPRSTR}$	Reset Recovery Time	—	1.20	—	1.20	—	1.50	—	1.50	—	1.56	—	ns
$t_{PDPRSTPW}$	Reset Pulse Width	—	0.14	—	0.14	—	0.18	—	0.18	—	0.19	—	ns
Dual Port RAM													
t_{DPMSAS}	Memory Select A Setup Before R/W A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t_{DPMSAH}	Memory Select Hold time after R/W A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t_{DPCEAS}	Clock Enable A Setup before Clock A Time	—	3.72	—	3.72	—	3.72	—	3.72	—	4.84	—	ns
t_{DPCEAH}	Clock Enable A Hold time after Clock A Time	—	-2.95	—	-2.95	—	-2.95	—	-2.95	—	-2.27	—	ns
$t_{DPADDAS}$	Address A Setup before Clock A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPADDAH}$	Address A Hold time after Clock A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t_{DPRWAS}	R/W A Setup before Clock A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t_{DPRWAH}	R/W A Hold time after Clock A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPDATAAS}$	Write Data A Setup before Clock A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPDATAAH}$	Write Data A Hold time after Clock A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t_{DPMSBS}	Memory Select B Setup Before R/W B Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t_{DPMSBH}	Memory Select Hold time after R/W B Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns

ispXPLD 5000MX Family Timing Adders

Parameter	Description	Base Param.	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{IOI} Input Adjusters													
LVTTL_in	Using 3.3V TTL	t_{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS_18_in	Using 1.8V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS_25_in	Using 2.5V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS_33_in	Using 3.3V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
AGP_1X_in	Using AGP 1x	t_{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t_{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t_{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t_{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
HSTL_IV_in	Using HSTL 2.5V, Class IV	t_{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
LVPECL_in	Using Low Voltage PECL	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
PCI_in	Using PCI	t_{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t_{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t_{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
t_{IOO} Output Adjusters – Output Signal Modifiers													
Slow Slew	Using Slow Slew (LVTTL and LVCMOS Outputs Only)	t_{IOBUF}, t_{IOEN}	—	0.9	—	0.9	—	0.9	—	0.9	—	0.9	ns
t_{IOO} Output Adjusters – Output Configurations													
LVTTL_out	Using 3.3V TTL Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVCMOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
LVCMOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns

Signal Descriptions

Signal Names	Descriptions
TMS	Input – This pin is the Test Mode Select input, which is used to control the IEEE 1149.1 state machine.
TCK	Input – This pin is the Test Clock input pin, used to clock the IEEE 1149.1 state machine.
TDI	Input – This pin is the IEEE 1149.1 Test Data in pin, used to load data.
TDO	Output – This pin is the IEEE 1149.1 Test Data out pin used to shift data out.
TOE	Input – Test Output Enable pin. TOE tristates all I/O pins when driven low.
GOE0, GOE1	Input – Global output enable inputs.
RESET	Input – This pin resets all the registers in the device. The global polarity for this pin is selectable on a global basis.þ The default is active low. An external pull-down is required when polarity is set to active high.
yzz	Input/Output – These are the general purpose I/O used by the logic array. *y* is the MFB reference (alpha) and z is the macrocell reference (numeric) y: A-X (768 macrocells) y: A-P (512 macrocells) y: A-H (256 macrocells) z: 0-31
GND	GND – Ground
NC	No connect
V_{CC}	V_{CC} – The power supply pins for core logic.
V_{CCO0}, V_{CCO1}, V_{CCO2}, V_{CCO3}	V_{CC} – The power supply pins for I/O banks 0, 1, 2, and 3.
V_{REF0}, V_{REF1}, V_{REF2}, V_{REF3}	Input – This pin defines the reference voltage for I/O banks 0, 1, 2, and 3.
GCLK0, GCLK1, GCLK2, GCLK3	Input – Global clock/clock enable inputs (see Figure 14 for differential pairing).
CLK_OUT0, CLK_OUT1	Output – Optional clock output from PLL 0 and 1.
PLL_RST0, PLL_RST1	Input – Optional input resets the M divider in PLL 0 and 1.
PLL_FBK0, PLL_FBK1	Input – Optional feedback input for PLL 0 and 1.
GNDP	GND – Ground for PLLs.
V_{CCP}	V_{CC} – The power supply pin for PLLs.
V_{CCJ}	V_{CC} – The power supply for the IEEE 1149.1 interface.
DATA*x*	I/O – sysCONFIG data pins, bit *x*.
CSB	Input – sysCONFIG interface chip select. Drive low to select sysCONFIG interface.
CFG0	Input – Defines SRAM configuration mode. Low: sysCONFIG port, high: E^2CMOS or IEEE 1149.1 TAP.
PROGRAMB	Input – Controls the programming of SRAM. Hold high for normal operation. Toggle low to reload SRAM from E^2 memory.
CCLK[1]	Input – Clock for sysCONFIG interface. Reads and writes occur on the rising edge of the clock.
READ[1]	Input – Drive high to perform reads from the sysCONFIG interface.
INITB	I/O – Indicates status of configuration. Can be driven low to inhibit configuration.
DONE	Output (open drain) – Indicates status of configuration.

1. These inputs should not toggle during power up for proper power-up configuration.

ispXPLD 5256MX Logic Signal Connections

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
0	61N	H30	G17	H17	H31	B1
0	61P	H28	G16	H16	H29	C1
0	62N	H26	G15	H15	H27	D3
0	62P	H24	G14	H14	H25	C2
0	63N	H22	G13	H13	H23	E3
0	63P	H21	G12	H12	-	D2
-	-	VCC	-	-	-	VCC
0	64N	H20	G11	H11	-	E2
0	64P	H18/CLK_OUT0	G10	H10	H19	F2
0	65N	H16	G9	H9	H17	F1
0	65P	H14	G8	H8	H15	G1
-	-	GND	-	-	-	GND
0	66N	H12	G7	H7	H13	F3
-	-	VCCO0	-	-	-	VCCO0
0	66P	H10	G6	H6	H11	G5
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)
0	67N	H8	G5	H5	H9	H5
0	67P	H6/PLL_RST0	G4	H4	H7	G4
0	68N	H5	-	-	-	G3
0	68P	H4/PLL_FBK0	-	-	-	H3
0	69N	H2	-	-	H3	G2
0	69P	H0	-	-	H1	H1
-	GCLK0P	GCLK0	-	-	-	H2
-	-	VCCJ	-	-	-	See Power Supply and NC Connections Table
-	GCLK0N	GCLK1	-	-	-	J2
-	-	GND	-	-	-	GND
-	-	TDI	-	-	-	H6
-	-	TMS	-	-	-	H4
-	-	TCK	-	-	-	J6
-	-	TDO	-	-	-	K2
1	0P	A0/DATA0	A0	B0	A1	K3
1	0N	A2/DATA1	A1	B1	A3	J3
1	1P	A4/DATA2	A2	B2	-	J5
1	1N	A5/DATA3	A3	B3	-	J4
1	2P	A6/DATA4	A4	B4	A7	L2
1	2N	A8/DATA5	A5	B5	A9	M1
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)
1	3P	A10/DATA6	A6	B6	A11	K4
-	-	VCCO1	-	-	-	VCCO1
1	3N	A12/DATA7	A7	B7	A13	L3
-	-	GND	-	-	-	GND
1	4P	A14/INITB	A8	B8	A15	K5

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	34N	E30	-	-	E31	H14
3	34P	E28	-	-	E29	G16
3	35N	E26	-	-	E27	G15
3	35P	E24/PLL_FBK1	-	-	E25	F15
3	36N	E22/PLL_RST1	E27	F27	E23	H12
3	36P	E21	E26	F26	-	G14
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	37N	E20	E25	F25	-	F16
-	-	VCCO3	-	-	-	VCCO3
3	37P	E18	E24	F24	E19	E16
-	-	GND	-	-	-	GND
3	38N	E16	E23	F23	E17	G13
3	38P	E14	E22	F22	E15	G12
3	39N	E12	E21	F21	E13	F14
3	39P	E10/CLK_OUT1	E20	F20	E11	E15
-	-	VCC	-	-	-	VCC
3	40N	E8	E19	F19	E9	D12
3	40P	E6	E18	F18	E7	B14
3	41N	E5	E17	F17	-	C13
3	41P	E4	E16	F16	-	A14
3	42N	E2	E31	F31	E3	A13
3	42P	E0	E30	F30	E1	B13
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
-	-	VCCO3	-	-	-	VCCO3
3	43N	F30	E15	F15	F31	B11
3	43P	F28	E14	F14	F29	C11
3	44N	F26	E13	F13	F27	B10
3	44P	F24	E12	F12	F25	A10
3	45N	F22	E11	F11	F23	C10
3	45P	F21	E10	F10	-	D10
3	46N	F20	E9	F9	-	C9
3	46P	F18	E8	F8	F19	E9
3	47N	F16/VREF3	E29	F29	F17	D9
3	47P	F14	E28	F28	F15	F9
3	48N	F12	E7	F7	F13	A9
3	48P	F10	E6	F6	F11	F8
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	49N	F8	E5	F5	F9	E8
-	-	VCCO3	-	-	-	VCCO3
3	49P	F6	E4	F4	F7	A8
3	50N	F5	E3	F3	-	B9
3	50P	F4	E2	F2	-	D8
-	-	VCC	-	-	-	VCC

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	51N	F2	E1	F1	F3	B8
3	51P	F0	E0	F0	F1	C8
0	52N	G30	G31	H31	G31	B7
0	52P	G28	G30	H30	G29	A7
-	-	GND	-	-	-	NC
0	53N	G26	G29	H29	G27	D7
0	53P	G24	G28	H28	G25	C7
0	54N	G22	G27	H27	G23	B6
-	-	VCCO0	-	-	-	VCCO0
0	54P	G21	G26	H26	-	E7
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)
0	55N	G20	G25	H25	-	E6
0	55P	G18	G24	H24	G19	A6
0	56N	G16/VREF0	G3	H3	G17	A5
0	56P	G14	G2	H2	G15	A4
0	57N	G12	G23	H23	G13	B5
0	57P	G10	G22	H22	G11	A3
0	58N	G8	G21	H21	G9	B4
0	58P	G6	G20	H20	G7	B3
0	59N	G5	G19	H19	-	C5
0	59P	G4	G18	H18	-	C6
0	60N	G2	G1	H1	G3	D5
0	60P	G0	G0	H0	G1	D6
-	-	VCCO0	-	-	-	VCCO0
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)

Global Clock LVDS pair options: GCLK0 and GCLK1, as well as GCLK2 and GCLK3, can be paired together to receive differential clocks; where GCLK0 and GCLK3 are the positive LVDS inputs

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
2	46N	G6	H19	-	G7	—	AB19
2	47P	G8	H20	-	G9	—	AA19
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	47N	G10	H21	-	G11	—	U17
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	48P	G12	H22	-	G13	—	V18
2	48N	G14	H23	-	G15	—	AB21
2	49P	G16	H24	-	G17	—	U18
2	49N	G18	H25	-	G19	—	T17
2	50P	G20	H26	-	G21	R16	AB20
2	50N	G22	H27	-	G23	P16	AA20
2	51P	G24	H28	-	G25	N15	Y19
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	51N	G26	H29	-	G27	N14	V19
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	52P	G28	F16	H16	G29	N16	T18
2	52N	G30	F17	H17	G31	M16	R17
2	53P	H0	F18	H18	H1	M14	U19
2	53N	H2	F19	H19	H3	M15	T19
2	54P	H4	H30	E24	H5	—	V20
-	-	VCC	-	-	-	VCC	VCC
2	54N	H6	H31	E26	H7	—	U20
2	55P	H8	F20	H20	H9	L13	W20
2	55N	H10	F21	H21	H11	L12	Y21
2	56P	H12	F22	H22	H13	L15	R18
2	56N	H14	F23	H23	H15	L16	R19
-	-	GND	-	-	-	GND	GND
2	57P	H16	F24	H24	H17	L14	W21
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	57N	H18	F25	H25	H19	K15	Y22
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	58P	H20	F26	H26	H21	K14	R20
2	58N	H22	F27	H27	H23	K12	P20
2	59P	H24	F28	H28	H25	K13	T21
2	59N	H26	F29	H29	H27	J13	R21
2	60P	H28	F30	H30	H29	J14	U21
2	60N	H30	F31	H31	H31	J12	V21
-	-	TOE	-	-	-	J15	W22
-	-	RESET	-	-	-	J11	V22
-	-	GOE0	-	-	-	H11	T22
-	-	GOE1	-	-	-	H13	R22
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table	

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCC	-	-	-	VCC	VCC
0	109P	Q28	Q30	S30	Q29	A7	C11
-	-	GND	-	-	-	GND	GND
0	110N	Q26	Q29	S29	Q27	D7	B11
0	110P	Q24	Q28	S28	Q25	C7	A11
0	111N	Q22	Q27	S27	Q23	B6	F11
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	111P	Q20	Q26	S26	Q21	E7	F10
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	112N	Q18	Q25	S25	Q19	E6	E10
0	112P	Q16	Q24	S24	Q17	A6	C10
0	113N	Q14/VREF0	Q3	S3	Q15	A5	D10
0	113P	Q12	Q2	S2	Q13	A4	B10
0	114N	Q10	Q23	S23	Q11	B5	A10
0	114P	Q8	Q22	S22	Q9	A3	A9
0	115N	Q6	Q21	S21	Q7	B4	C9
0	115P	Q4	Q20	S20	Q5	B3	D9
0	116N	Q2	Q19	S19	Q3	C5	F9
0	116P	Q0	Q18	S18	Q1	C6	E9
0	117N	R30	Q1	S1	R31	D5	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	117P	R28	Q0	S0	R29	D6	B8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	118N	R26	S29	-	R27	—	A7
0	118P	R24	S28	-	R25	—	B7
0	119N	R22	S27	-	R23	—	A5
0	119P	R20	S26	-	R21	—	B5
0	120N	R18	S25	-	R19	—	B6
0	120P	R16	S24	-	R17	—	C7
0	121N	R14	S23	-	R15	—	E8
0	121P	R12	S22	-	R13	—	E7
0	122N	R10	S21	-	R11	—	E6
-	-	VCC	-	-	-	VCC	VCC
0	122P	R8	S20	-	R9	—	D6
-	-	GND	-	-	-	GND	GND
0	123N	R6	S19	-	R7	—	D8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	123P	R4	S18	-	R5	—	F8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	124N	R2	S17	-	R3	—	F7
0	124P	R0	S16	-	R1	—	D7
0	125N	S30	S15	-	S31	A2	C6
0	125P	S28	S14	-	S29	B2	C5

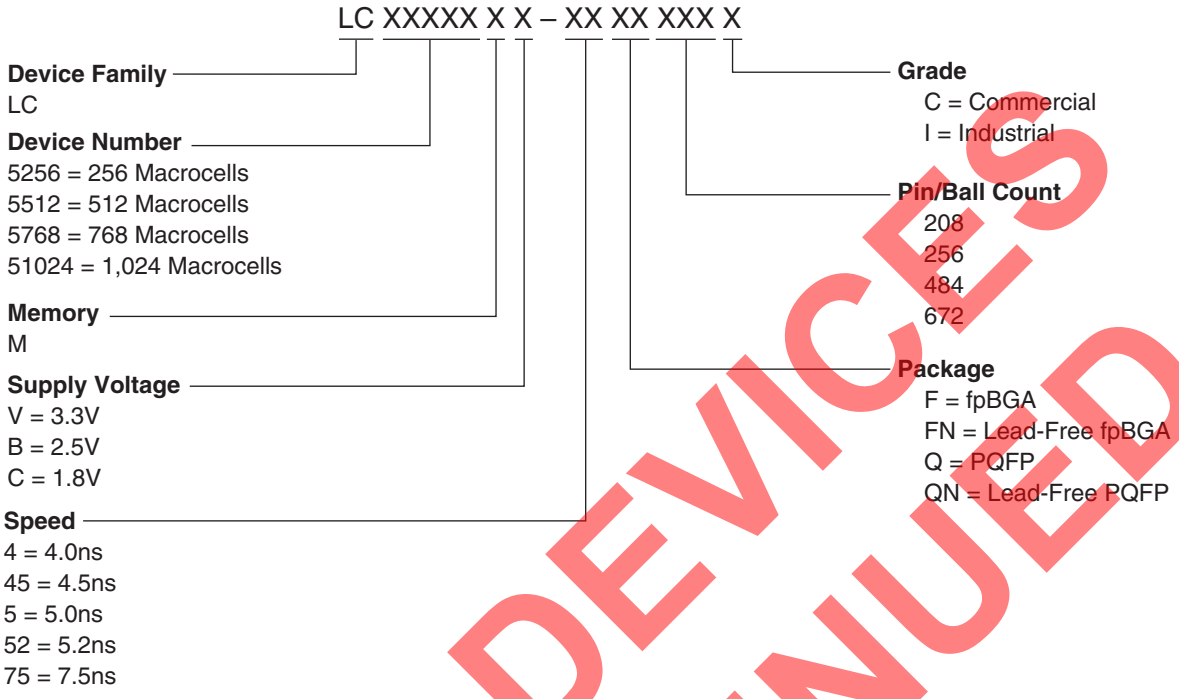
ispXPLD 51024MX Logic Signal Connections

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	159N	AA22	AA11	AB18	AA23	B4	C2
0	159P	AA20	AA10	AB16	AA21	A4	C1
0	160N	AA18	Y17	AA17	AA19	B3	D4
0	160P	AA16	Y16	AA16	AA17	A3	D3
0	161N	AA14	Y15	AA15	AA15	F5	D2
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	161P	AA12	Y14	AA14	AA13	G6	D1
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	162N	AA10	Y13	AA13	AA11	H6	E5
0	162P	AA8	Y12	AA12	AA9	G5	E4
0	163N	AA6	AA9	AB14	AA7	D3	E3
0	163P	AA4	AA8	AB12	AA5	D2	E2
0	164N	AA2	AA7	AB10	AA3	E4	E1
-	-	VCC	-	-	-	VCC	VCC
0	164P	AA0	AA6	AB8	AA1	E3	F2
-	-	GND	-	-	-	GND	GND
0	165N	AB30	AA5	AB6	AB31	F4	F5
0	165P	AB28	AA4	AB4	AB29	G4	G6
0	166N	AB26	AA3	AB2	AB27	C2	F4
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	166P	AB24	AA2	AB0	AB25	C1	F3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	167N	AB22	AA1	-	AB23	F3	F1
0	167P	AB20	AA0	-	AB21	G3	G1
0	168N	AB18	AA31	-	AB19	H4	G5
-	-	VCC	-	-		VCC	VCC
0	168P	AB16	AA30	-	AB17	J4	G4
0	169N	AB14	Y11	AA11	AB15	H5	H7
0	169P	AB12/CLK_OUT0	Y10	AA10	AB13	J5	J7
0	170N	AB10	Y9	AA9	AB11	E2	G3
0	170P	AB8	Y8	AA8	AB9	F2	G2
-	-	GND	-	-	-	GND	GND
0	171N	AB6	Y7	AA7	AB7	D1	H6
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	171P	AB4	Y6	AA6	AB5	E1	J6
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	172N	AB2	Y5	AA5	AB3	J3	H5
0	172P	AB0/PLL_RST0	Y4	AA4	AB1	H2	H4
0	173N	AC30	AC31	AE31	AC31	G2	H3
0	173P	AC28/PLL_FBK0	AC30	AE30	AC29	G1	H2
0	174N	AC26	AC29	AE29	AC27	J6	H1
0	174P	AC24	AC28	AE28	AC25	K4	J1

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
3	126N	W4	V11	U21	W5	B18	E19
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	126P	W6	V10	U20	W7	A18	E18
-	-	GND	-	-	-	GND	GND
3	127N	W8	V9	U18	W9	C17	C24
-	-	VCC	-	-	-	VCC	VCC
3	127P	W10	V8	U16	W11	B17	C23
3	128N	W12	V7	U12	W13	C16	D22
3	128P	W14	V6	U10	W15	B16	D21
3	129N	W16	V5	U8	W17	F13	E21
3	129P	W18	V4	U6	W19	F15	D20
3	130N	W20	V3	U5	W21	D16	D19
3	130P	W22	V2	U4	W23	E16	D18
3	131N	W24	V1	U2	W25	A16	C22
3	131P	W26	V0	U0	W27	A15	C21
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	132N	W28	X15	V15	W29	B15	C20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	132P	W30	X14	V14	W31	A14	C19
3	133N	X0	X13	V13	X1	D15	C18
3	133P	X2	X12	V12	X3	E15	C17
3	134N	X4	X11	V11	X5	D14	B24
3	134P	X6	X10	V10	X7	F14	B23
3	135N	X8	X9	V9	X9	A13	B22
3	135P	X10	X8	V8	X11	B13	B21
3	136N	X12/VREF3	X29	V29	X13	C14	B20
3	136P	X14	X28	V28	X15	E14	B19
3	137N	X16	X7	V7	X17	E13	B18
3	137P	X18	X6	V6	X19	F12	B17
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	138N	X20	X5	V5	X21	D13	A24
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	138P	X22	X4	V4	X23	C13	A23
3	139N	X24	X3	V3	X25	E12	A22
-	-	GND	-	-	-	GND	GND
3	139P	X26	X2	V2	X27	C12	A21
-	-	VCC	-	-	-	VCC	VCC
3	140N	X28	X1	V1	X29	B12	A20
3	140P	X30	X0	V0	X31	A12	A19
0	141N	Y30	Y31	AA31	Y31	E11	A18
-	-	VCC	-	-	-	VCC	VCC
0	141P	Y28	Y30	AA30	Y29	C11	A17
-	-	GND	-	-	-	GND	GND

Part Number Description



Ordering Information

Note: For voltage families offered in industrial temperature grades and for all but the slowest commercial speed grade, the speed grades on these devices are dual marked. For example, the commercial speed grade -45XXXXC is also marked with the industrial grade -75I. The commercial grade is always one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade is marked as commercial grade only. In addition, the fastest commercial speed grade (-5) for the LC5768MB/MV devices, at Lattice's discretion, will utilize either a commercial grade only single-mark or a dual-mark format in conjunction with the slower industrial speed grade (-75).

Conventional Packaging

ispXPLD 5000MC (1.8V) Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t_{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-4F256C	256	1.8	4.0	fpBGA	256	141	C
	LC5256MC-5F256C	256	1.8	5.0	fpBGA	256	141	C
	LC5256MC-75F256C	256	1.8	7.5	fpBGA	256	141	C
LC5512MC	LC5512MC-45Q208C	512	1.8	4.5	PQFP	208	149	C
	LC5512MC-75Q208C	512	1.8	7.5	PQFP	208	149	C
	LC5512MC-45F256C	512	1.8	4.5	fpBGA	256	193	C
	LC5512MC-75F256C	512	1.8	7.5	fpBGA	256	193	C
	LC5512MC-45F484C	512	1.8	4.5	fpBGA	484	253	C
	LC5512MC-75F484C	512	1.8	7.5	fpBGA	484	253	C

ispXPLD 5000MB (2.5V) Industrial Devices

Device	Part Number	Macrocells	Voltage (V)	t_{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MB	LC5256MB-5F256I	256	2.5	5.0	fpBGA	256	141	I
	LC5256MB-75F256I	256	2.5	7.5	fpBGA	256	141	I
LC5512MB	LC5512MB-75Q208I	512	2.5	7.5	PQFP	208	149	I
	LC5512MB-75F256I	512	2.5	7.5	fpBGA	256	193	I
	LC5512MB-75F484I	512	2.5	7.5	fpBGA	484	253	I
LC5768MB	LC5768MB-75F256I	768	2.5	7.5	fpBGA	256	193	I
	LC5768MB-75F484I	768	2.5	7.5	fpBGA	484	317	I
LC51024MB	LC51024MB-75F484I	1024	2.5	7.5	fpBGA	484	317	I
	LC51024MB-75F672I	1024	2.5	7.5	fpBGA	672	381	I

ispXPLD 5000MV (3.3V) Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t_{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MV	LC5256MV-4F256C	256	3.3	4.0	fpBGA	256	141	C
	LC5256MV-5F256C	256	3.3	5.0	fpBGA	256	141	C
	LC5256MV-75F256C	256	3.3	7.5	fpBGA	256	141	C
LC5512MV	LC5512MV-45Q208C	512	3.3	4.5	PQFP	208	149	C
	LC5512MV-75Q208C	512	3.3	7.5	PQFP	208	149	C
	LC5512MV-45F256C	512	3.3	4.5	fpBGA	256	193	C
	LC5512MV-75F256C	512	3.3	7.5	fpBGA	256	193	C
	LC5512MV-45F484C	512	3.3	4.5	fpBGA	484	253	C
	LC5512MV-75F484C	512	3.3	7.5	fpBGA	484	253	C
LC5768MV	LC5768MV-5F256C	768	3.3	5.0	fpBGA	256	193	C
	LC5768MV-75F256C	768	3.3	7.5	fpBGA	256	193	C
	LC5768MV-5F484C	768	3.3	5.0	fpBGA	484	317	C
	LC5768MV-75F484C	768	3.3	7.5	fpBGA	484	317	C
LC51024MV	LC51024MV-52F484C	1024	3.3	5.2	fpBGA	484	317	C
	LC51024MV-75F484C	1024	3.3	7.5	fpBGA	484	317	C
	LC51024MV-52F672C	1024	3.3	5.2	fpBGA	672	381	C
	LC51024MV-75F672C	1024	3.3	7.5	fpBGA	672	381	C

ispXPLD 5000MV (3.3V) Industrial Devices

Device	Part Number	Macrocells	Voltage (V)	t_{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MV	LC5256MV-5F256I	256	3.3	5.0	fpBGA	256	141	I
	LC5256MV-75F256I	256	3.3	7.5	fpBGA	256	141	I
LC5512MV	LC5512MV-75Q208I	512	3.3	7.5	PQFP	208	149	I
	LC5512MV-75F256I	512	3.3	7.5	fpBGA	256	193	I
	LC5512MV-75F484I	512	3.3	7.5	fpBGA	484	253	I
LC5768MV	LC5768MV-75F256I	768	3.3	7.5	fpBGA	256	193	I
	LC5768MV-75F484I	768	3.3	7.5	fpBGA	484	317	I
LC51024MV	LC51024MV-75F484I	1024	3.3	7.5	fpBGA	484	317	I
	LC51024MV-75F672I	1024	3.3	7.5	fpBGA	672	381	I